

C3M0021120K

Silicon Carbide Power MOSFET C3M[™] MOSFET Technology N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances ٠
- Fast intrinsic diode with low reverse recovery (Q,,) •
- Halogen free, RoHS compliant

Halogen-Free		Tab Drain Control A 3 4 5 5 G
ROHS compliant	PIN 4 (GATE) PIN 3 (DRIVER SOURCE)	PIN 1, TAB (DRAIN) PIN 2 (POWER SOURCE)
Part Number	Package	Marking

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C3M0021120K	TO 247-4	C3M0021		

21120K

Applications

- Solar inverters
- EV motor drive
- High voltage DC/DC converters
- Switched mode power supplies
- Load switch

Benefits

- Reduce switching losses and minimize gate ringing •
- Higher system efficiency •
- Reduce cooling requirements •
- Increase power density •
- Increase system switching frequency

Maximum Ratings ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Value	Unit	Test Conditions	Note
Drain-Source Voltage	V _{DS max}	1200		$V_{GS} = 0 V, I_D = 100 \mu A$	
Gate-Source Voltage (dynamic) ¹	V _{GS max}	-8/+19	V	AC (f > 1 Hz)	
Gate-Source Voltage (static) ²	V _{GS op}	-4/+15		Static	
Continuous Drain Current	Ι _D	100	A	$V_{GS} = 15 V, T_{C} = 25^{\circ}C$	Fig. 19
		74		$V_{GS} = 15 \text{ V}, \text{T}_{C} = 100^{\circ}\text{C}$	
Pulsed Drain Current	I _{D(pulsed)}	200		Pulse width t _P limited by T _{jmax}	
Power Dissipation	PD	469	W	T _c = 25°C, T _J = 175°C	Fig. 20
Operating Junction and Storage Temperature	T _J , T _{stg}	-40 to +175	*6		
Solder Temperature	TL	260	°C	1.6mm (0.063") from case for 10s	

Note:

 1 When using MOSFET Body Diode V $_{\rm GS\,max}$ = -4V/+19V 2 MOSFET can also safely operate at 0/+15 V



Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	1200	_	_		$V_{GS} = 0 V, I_{D} = 100 \mu A$	
Gate Threshold Voltage		1.8	2.5	3.6	V	$V_{DS} = V_{GS}$, $I_D = 17.7$ mA	- Fig. 11
	$V_{GS(th)}$	_	2.0	_		$V_{DS} = V_{GS}$, $I_D = 17.7$ mA, $T_J = 175^{\circ}$ C	
Zero Gate Voltage Drain Current	I _{DSS}	_	1	50	μA	$V_{DS} = 1200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	
Gate-Source Leakage Current	I _{GSS}	_	10	250	μΑ	$V_{GS} = 15 V, V_{DS} = 0 V$	
Drain-Source On-State Resistance	_		21	28.8		$V_{GS} = 15 \text{ V}, I_D = 50 \text{ A}$	Fig. 4,
Dram-source on-state resistance	$R_{DS(on)}$	_	38	_	mΩ	$V_{GS} = 15 \text{ V}, I_D = 50 \text{ A}, T_J = 175^{\circ}\text{C}$	5,6
Transconductance	-		35			$V_{DS} = 20 \text{ V}, I_{DS} = 50 \text{ A}$	Fig. 7
Transconductance	g _{fs}	_	33	_	S	$V_{DS} = 20 \text{ V}, I_{DS} = 50 \text{ A}, T_{J} = 175^{\circ}\text{C}$	
Input Capacitance	C _{iss}	-	4818	_			Fig. 17, 18
Output Capacitance	Coss	_	180	_	pF	$V_{GS} = 0 V, V_{DS} = 1000 V$	
Reverse Transfer Capacitance	C _{rss}	_	12	_		$\begin{cases} f = 1 \text{ Mhz} \\ V_{AC} = 25 \text{ mV} \end{cases}$	
C _{oss} Stored Energy	E _{oss}	_	99	_	μJ		Fig. 16
Turn-On Switching Energy (SiC Diode FWD)	Eon	_	0.69	_		$\begin{split} V_{DS} &= 800 \text{ V}, V_{GS} = -4 \text{ V} / +15 \text{ V}, \text{ I}_{D} = 50 \text{ A}, \\ R_{G(ext)} &= 2.5 \ \Omega, \text{ L} = 157 \ \mu\text{H}, \\ \text{T}_{J} &= 175^{\circ}\text{C} \end{split}$	Fig. 26, 29
Turn Off Switching Energy (SiC Diode FWD)	E _{off}	_	0.42	_			
Turn-On Switching Energy (Body Diode FWD)	Eon	_	1.58	_	mJ		
Turn Off Switching Energy (Body Diode FWD)	E _{off}	_	0.34	_			
Turn-On Delay Time	t _{d(on)}		29	_			
Rise Time	t _r		33	_		$V_{DD} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$	Fig. 27
Turn-Off Delay Time	t _{d(off)}		57	_	ns	$R_{G(ext)} = 2.5 \Omega, L = 157 \mu H$	
Fall Time	t _f		14				
Internal Gate Resistance	R _{G(int)}		3.3	_	Ω	f = 1 MHz, V _{AC} = 25 mV	
Gate to Source Charge	Q _{gs}		49	_			Fig. 12
Gate to Drain Charge	Q _{gd}	_	50	_	nC	$V_{DS} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$ $I_D = 50 \text{ A}$	
Total Gate Charge	Qg		162	_		Per IEC60747-8-4 pg 21	

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Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Diada Famuard Valtaga	N	4.6	-	N N	$V_{GS} = -4 V, I_{SD} = 25 A, T_{J} = 25^{\circ}C$	Fig.
Diode Forward Voltage	orward Voltage V _{SD} V		$V_{GS} = -4 V$, $I_{SD} = 25 A$, $T_{J} = 175^{\circ}C$	8, 9, 10		
Continuous Diode Forward Current ¹	ls	_	90		$V_{GS} = -4 V, T_{C} = 25^{\circ}C$	
Diode Pulse Current ¹	I _{S, pulse}	-	200	A	V_{GS} = -4 V, pulse width t _P limited by T _{j max}	
Reverse Recovery Time ¹	t _{rr}	34	-	ns		
Reverse Recovery Charge ¹	Q _{rr}	928	_	nC	$V_{GS} = -4 V, I_{SD} = 50 A, V_R = 800 V$ $di_c/dt = 2600 A/\mu s, T_J = 175^{\circ}C$	
Peak Reverse Recovery Current ¹	I _{RRM}	42	_	A		

Note:

 1 When using MOSFET Body Diode V $_{\rm GS\,max}$ = -4V/+19V

Thermal Characteristics

Parameter	Symbol	Тур.	Unit	Test Conditions	Notes
Thermal Resistance from Junction to Case	R _{θJC}	0.32	°C /W		
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	40	°C/W		Fig. 21





Figure 5. On-Resistance vs. Drain Current For Various Temperatures **Figure 6.** On-Resistance vs. Temperature For Various Gate Voltage

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Figure 11. Threshold Voltage vs. Temperature



Figure 8. Body Diode Characteristic at -40°C



Figure 10. Body Diode Characteristic at 175°C



Figure 12. Gate Charge Characteristics

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Figure 13. 3rd Quadrant Characteristic at -40°C



Figure 15. 3rd Quadrant Characteristic at 175°C







Figure 14. 3rd Quadrant Characteristic at 25°C



Figure 16. Output Capacitor Stored Energy



Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)

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Figure 20. Maximum Power Dissipation Derating vs. Case Temperature



Figure 22. Safe Operating Area



Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800 V)

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Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}



Figure 27. Switching Times vs. R_{G(ext)}



Figure 26. Clamped Inductive Switching Energy vs. Temperature



Figure 28. Switching Times Definition

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Test Circuit Schematic¹



Figure 29. Clamped Inductive Switching Waveform Test Circuit

Note:

¹ Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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Package Dimensions – Package TO-247-4L



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Recommended Solder Pad Layout



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The Silicon Carbide MOSFET module switches at speeds beyond what is customarily associated with IGBT-based modules. Therefore, special precautions are required to realize optimal performance. The interconnection between the gate driver and module housing needs to be as short as possible. This will afford optimal switching time and avoid the potential for device oscillation. Also, great care is required to insure minimum inductance between the module and DC link capacitors to avoid excessive VDS overshoot.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

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Contact info:

4600 Silicon Drive Durham, NC 27703 USA Tel: +1.919.313.5300 www.wolfspeed.com/power